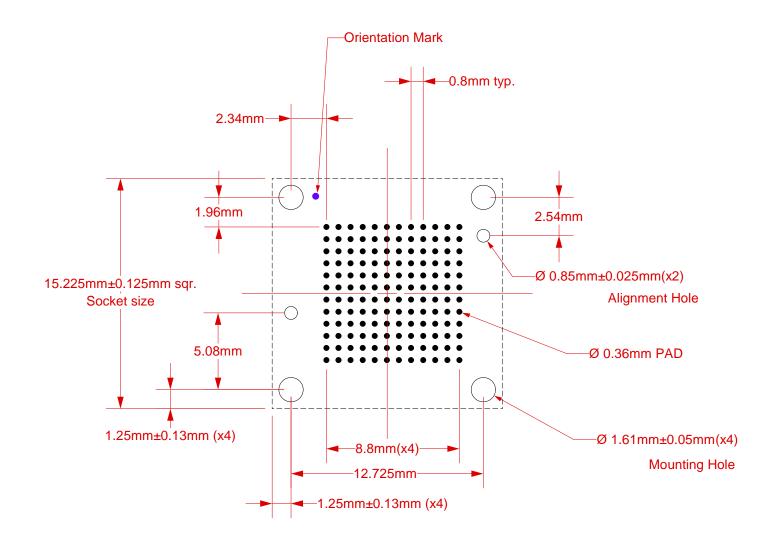


/11

olerances: ±0.125mm (unless stated erwise). Materials and specifications subject to change without notice.

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SG-BGA-6059 Drawing	Status: Released	Scale	: - N/A	Rev: D	All tole otherv
© 2002 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121	Drawing: H. Hansen		Date: 8/14/02		are su
Tele: (651) 452-8100 www.ironwoodelectronics.com	File: SG-BGA-6059 Dwg.mcd		Modified: 6/2/09, AE		

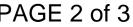


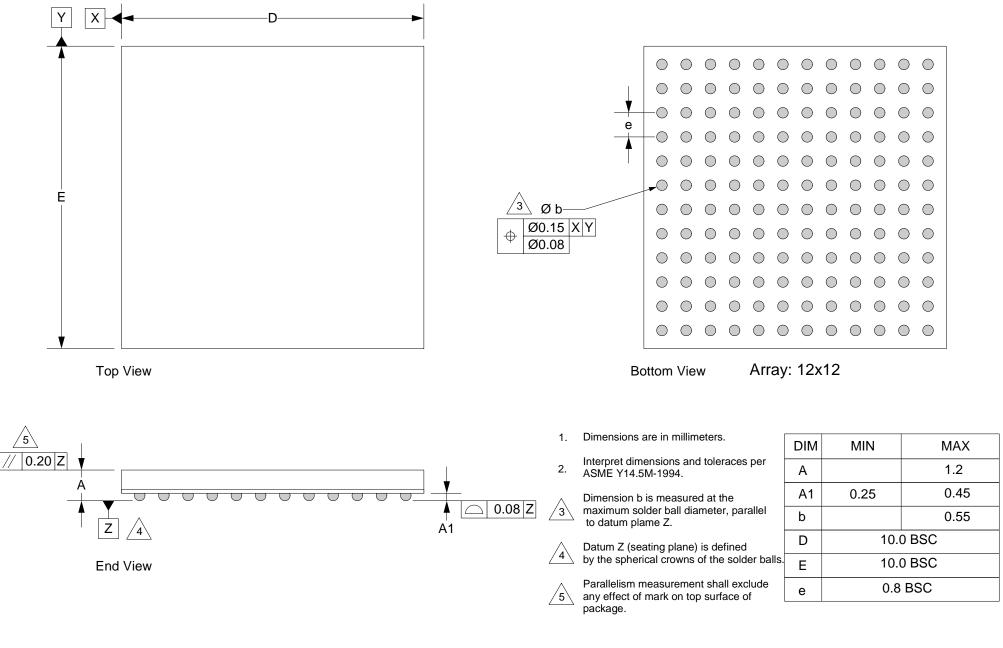
Target PCB Recommendations Total thickness: 1.6mm min. Plating: Gold or Solder finish PCB Pad height: Same or higher than solder mask

NOTE: Steel backing plate may be required based on end user's application

Recommended PCB Layout Tolerances: ±0.025mm [±0.001"] unless stated otherwise.

SG-BGA-6059 Drawing	Status: Released	Scale: 4:1	Rev: D	
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SG-BGA-6059 Drawing	Status: Released	Scale:	- N/A	Rev: D	
© 2002 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121	Drawing: H. Hansen Date: 8/1		Date: 8/14	14/02	P
Tele: (651) 452-8100 www.ironwoodelectronics.com	File: SG-BGA-6059 Dwg.mcd	BGA-6059 Dwg.mcd		: 6/2/09, AE	

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